(Rev. 10/02)

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U.S. DEPARTMENT OF COMMERCE

Docket No.: 067161-0328	PATENTS ONLY
	rademarks: Please record the attached original documents or copy thereto:
1. Name of Conveying Party(ies): Hiroaki TANIZAKI, Hideto HIDAKA	2. Name and address of receiving party(ies): Name: RENESAS TECHNOLOGY CORP.
	Address: 4-1, Marunouchi 2-chome,
Additional name(s) of conveying party(ies) attached?	51
3. Nature of Conveyance:	Tokyo, 100-6334 JAPAN
Security Agreement Change of	Name
Other	
Execution Date: February 23, 2006	Additional name(s) & address(ss) attached 2 V
4. Application number(s) or patent number(s):	Additional name(s) & address(es) attached? Yes
If the document is being filed together with a new app	plication, the execution date of the application is: February 23, 2006
A. Patent Application No(s).	B. Patent No(s).
	D. 1 atent (40(3).
5. Name and address of party to whom correspondence	numbers attached? Yes No 6. Total number of applications and patents involved:
concerning document should be mailed: Name: MCDERMOTT WILL & EMERY LLP	7. 7. 4.15. (27.070.044)
Internal Address:	7. Total fee (37 CFR 3.41) \$40.00
mema Address.	Enclosed
Street Address: 600 13th Street, N.W.	Authorized to be charged to deposit account 8. Deposit account number:
5.055.1. 1.1.1 50.	500417
City: Washington State: D. C. Zip:	20005-3096
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9. Statement and signature.	
To the best of my knowledge and belief, the fore	going information is true and correct and any attached copy is a true copy
of the original document.	
Gene Z. Rubinson, Registration No. 33,351	Sure 3. Rubium March 16, 2006
Name and Registration No. of Person Signing	Signature Date
	Total number of pages including cover sheet: 3

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> **PATENT** REEL: 017658 FRAME: 0101

Attorney	Docket	No.:	
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ASSIGNMENT

WHEREAS, Hiroaki TANIZAKI and Hideto HIDAKA, hereinafter called the "Assignors," have jointly invented a new and useful invention entitled Nonvolatile Semiconductor Memory Device, for which he has:

(a)	filed an application for United States Letters Patent onas (Serial No); or
(b)	executed an application for United States Letters Patent on February 23, 2006; or
(c)	filed a provisional application on as (Serial No); and

WHEREAS, Renesas Technology Corp., a corporation organized and existing under the laws of <u>Japan</u>, having a place of business at:

4-1, Marunouchi 2-chome, Chiyoda-ku, TOKYO 100-6334 JAPAN, hereinafter called the "Assignee," is desirous of acquiring the entire right, title and interest in and to said invention, the application above identified, and in, to and under any Letters Patent which may be obtained to said invention, as hereinafter more fully set forth:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of One Dollar (\$1.00), and other valuable and legally sufficient considerations, the receipt of which by said Assignors from the said Assignee is hereby acknowledged, the said Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said Assignee, the entire, right, title and interest for the United States in and to the invention and application hereinabove identified, and any Letters Patent of the United States that may issue for said invention, together with the entire right, title and interest in and to said invention and applications for Letters Patent and Letters Patent therefor, in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; to have and to hold for the sole and exclusive use and benefit of the said Assignee, its successors and assigns, to the full end of the term or terms for which any and all of said Letters Patent for said inventions may issue.

PATENT REEL: 017658 FRAME: 0102 And the said Assignors do hereby covenant and agree, for himself and his legal representatives, that he will assist the said Assignee in the prosecution of the application herein identified; in the making and prosecution of any other applications for Letters Patent that the said Assignee may elect to make covering the invention herein identified, as hereinabove set forth; in vesting in the said Assignee like exclusive title in and to all such other applications and Letters Patent; and in the prosecution of any interference which may arise involving said invention, or any application or Letters Patent herein contemplated; and that they will execute and deliver to the said Assignee any and all additional papers which may be requested by the said Assignee to fully carry out the terms of this Assignment.

The undersigned hereby grant(s) the attorneys of McDermott, Will & Emery LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

And the Commissioner of Patents and Trademarks is hereby authorized and requested to issue Letters Patent to the said Assignee in accordance with the terms of this Assignment.

IN TESTIMONY WHEREOF, the said Assignors have hereunto set his hands and affixed his seal.

Date:	February 23, 2006	Kiroaki Tanizaki Hiroaki TANIZAKI	_ (Seal)
Date:	February 23, 2006	Hideto HIDAKA	_ (Seal)
Date:			(Seal)
Date:			_ (Seal)
Date:			_ (Seal)
Date:			_ (Seal)